

S1C17001

CMOS 16-bit Single Chip Microcontroller

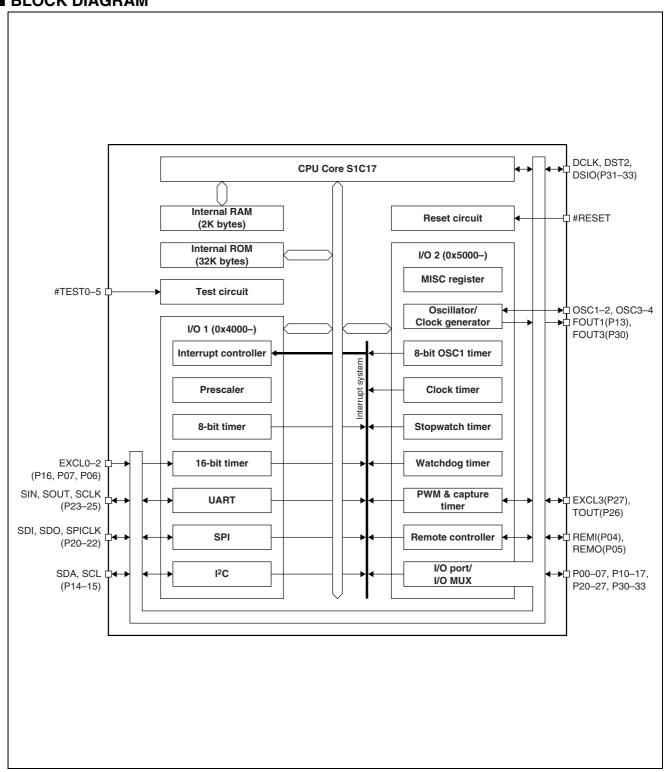
- Low Power MCU (operating voltage 1.8 V, 0.5 µA/SLEEP, 2.5 µA/HALT)
- S1C17 High Performance 16-bit RISC CPU Core with C Optimized Compact Code and Serial ICE Support
- Infrared Remote Controller with Carrier Generator
- 32K-Byte ROM and 2K-Byte RAM

■ DESCRIPTIONS

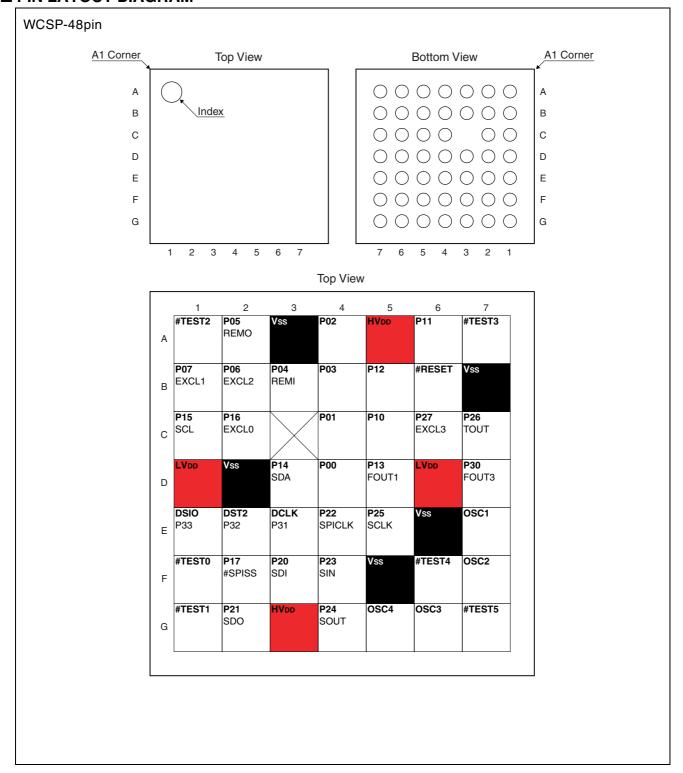
The S1C17001 is a 16-bit MCU that features high-speed operation, low power consumption, small size, large address space, and on-chip ICE. The S1C17001 consists of an S1C17 CPU Core, a 32K-byte ROM, a 2K-byte RAM, serial interface modules (UART that supports high bit rate and IrDA 1.0, SPI and I²C) for connecting various sensor modules, 8-bit timers, 16-bit timers, a PWM & capture timer, a clock timer, a stopwatch timer, a watchdog timer and 28 GPIO ports. The S1C17001 is capable of high-speed operation (8.2 MHz) with low operating voltage (1.8 V). Its 16-bit RISC processor executes one instruction in one clock cycle. The S1C17001 also provides an on-chip ICE function that allows on-board debugging and evaluating the program by connecting the S1C17001 to the ICD Mini (S5U1C17001H) or ICD board with only three wires.

I FEATURES	
● CPU	 Seiko Epson original 16-bit RISC CPU core S1C17
Main (OSC3) oscillator	 Crystal/ceramic oscillator or external clock input 8.2 MHz (max.)
Sub (OSC1) oscillator	 Crystal oscillator or external clock input 32.768 kHz (typ.)
● On-chip ROM	32K bytes
● On-chip RAM	2K bytes
I/O ports	• Max. 28 general-purpose I/O ports (Pins are shared with the peripheral I/O.)
Serial interfaces	• SPI (master/slave) 1 ch.
•	• I ² C (master) 1 ch.
•	• UART (with IrDA 1.0) 1 ch.
•	• Remote controller (REMC) 1 ch.
Timers	8-bit timer (T8F) 1 ch.
	• 16-bit timer (T16) 3 ch.
•	PWM & capture timer (T16E) 1 ch.
	• Clock timer (CT) 1 ch.
	• Stopwatch timer (SWT) 1 ch.
	• Watchdog timer (WDT) 1 ch.
•	8-bit OSC1 timer (T8OSC1) 1 ch.
Interrupts	
	• NMI
•	14 hardware interrupts (8 levels)
	• Core voltage (LVDD) 1.65 V to 2.7 V
•	I/O voltage (HVDD) 1.65 V to 3.6 V
Operating temperature	-40°C to 85°C
● Current consumption (typ.)	• SLEEP state: 0.5 μA
•	• HALT state: 2.5 μA (32 kHz)
•	Pun state: 10 μA (32 kHz)
	1800 μA (8 MHz)
Shipping form	WCSP-48pin plastic package
 Flash memory model for 	
developing mask ROM code	• S1C17704

■ BLOCK DIAGRAM



■ PIN LAYOUT DIAGRAM

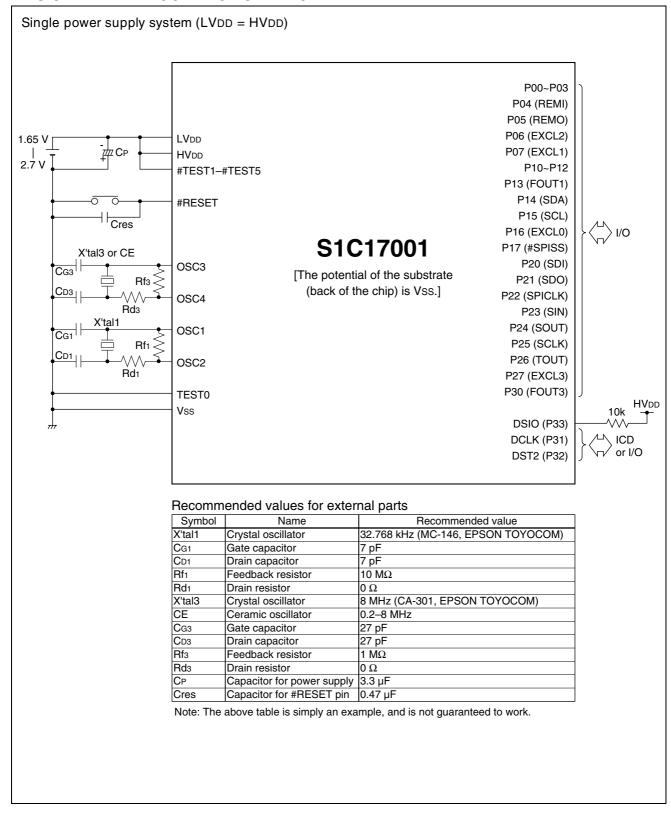


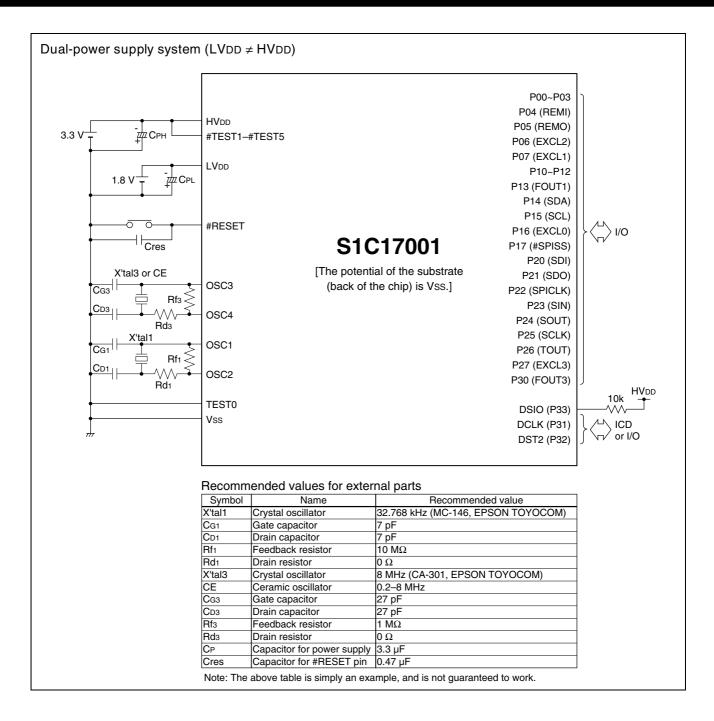
■ PIN DESCRIPTION

No.	Pin name	<u>-</u> I/O	Initial	Function
1	Vss	1	iiiilai	Power supply pin (GND)
2	#TEST1	_ 	I (Pull-UP)	Test pin (fix at high during normal operation)
3	#TEST2	i	I (Pull-UP)	Test pin (fix at high during normal operation)
4	#TEST3	i	I (Pull-UP)	Test pin (fix at high during normal operation)
5	#TEST4	i	I (Pull-UP)	Test pin (fix at high during normal operation)
6	#TEST5	i	I (Pull-UP)	Test pin (fix at high during normal operation)
7	OSC3	i		OSC3 oscillation input pin (external clock may be input)
8	OSC4	0	0	OSC3 oscillation output pin
9	OSC1	ī	ī	OSC1 oscillation input pin (external clock may be input)
10	OSC2	0	0	OSC1 oscillation output pin
11	HVDD	_	_	Power supply pin (HVDD+)
12	Vss	_	_	Power supply pin (GND)
13	#TEST0	ı	I (Pull-UP)	Test pin (fix at high during normal operation)
14	#RESET	ı	I (Pull-UP)	Initial reset input pin
15	DSIO/P33	I/O	I (Pull-UP)	On-chip debugger data I/O pin* or I/O port pin
16	DST2 /P32	I/O	O (L)	On-chip debugger status output pin* or I/O port pin
17	DCLK/P31	I/O	O (H)	On-chip debugger clock output pin* or I/O port pin
18	P30/FOUT3	I/O	I (Pull-UP)	I/O port pin* or OSC3 divider clock output pin
19	P27/EXCL3	I/O	I (Pull-UP)	I/O port pin* or T16E external clock input pin
20	P26/TOUT	I/O	I (Pull-UP)	I/O port pin* or T16E PWM signal output pin
21	P25/SCLK	I/O	I (Pull-UP)	I/O port pin* or UART clock input pin
22	P24/SOUT	I/O	I (Pull-UP)	I/O port pin* or UART data output pin
23	P23 /SIN	I/O	I (Pull-UP)	I/O port pin* or UART data input pin
24	P22/SPICLK	I/O	I (Pull-UP)	I/O port pin* or SPI clock I/O pin
25	P21 /SDO	I/O	I (Pull-UP)	I/O port pin* or SPI data output pin
26	P20 /SDI	I/O	I (Pull-UP)	I/O port pin* or SPI data input pin
27	P17/#SPISS	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or SPI slave select input pin
28	P16/EXCL0	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or T16 Ch.0 external clock input pin
29	P15/SCL	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or I ² C clock output pin
30	P14/SDA	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or I ² C data I/O pin
31	P13/FOUT1	I/O	I (Pull-UP)	I/O port pin (with interrupt)* or OSC1 clock output pin
32	P12	I/O	I (Pull-UP)	I/O port pin (with interrupt)
33	P11	I/O	I (Pull-UP)	I/O port pin (with interrupt)
34	P10	I/O	I (Pull-UP)	I/O port pin (with interrupt)
35	P07/EXCL1	1/0	I (Pull-UP)	I/O port pin (with interrupt)* or T16 Ch.1 external clock input pin
36	P06/EXCL2	1/0		I/O port pin (with interrupt)* or T16 Ch.2 external clock input pin
37	P05/REMO	1/0	I (Pull-UP)	I/O port pin (with interrupt)* or Remote control signal output pin
38	P04/REMI	1/0	I (Pull-UP)	I/O port pin (with interrupt)* or Remote control signal input pin
39	P03	I/O	I (Pull-UP)	I/O port pin (with interrupt)
40	HVDD	-	_	Power supply pin (HVDD+)
41 42	Vss P02	- I/O	I (Pull-UP)	Power supply pin (GND) I/O port pin (with interrupt)
42	P02 P01	1/0	I (Pull-UP)	I/O port pin (with interrupt)
43	P00	1/0	I (Pull-UP)	I/O port pin (with interrupt)
44	LVDD	1/0	- (i uii-UF)	Power supply pin (LVDD+)
46	Vss	_		Power supply pin (CVDD+) Power supply pin (GND)
47	LVDD	_		Power supply pin (GND) Power supply pin (LVDD+)
47	Vss	_		Power supply pin (GND)
40	V 33	_		li omei anbbià hiii (aian)

Note: The pin names described in boldface type and description with '*' are default settings.

■ BASIC EXTERNAL CONNECTION DIAGRAM





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IC Sales Dept.
IC International Sales Group
421-8, Hino, Hino-shi, Tokyo 191-8501, JAPAN
Phone: +81-42-587-5814 FAX: +81-42-587-5117

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